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Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
USPTO Use Only

EFS ID: 43558  
Application ID: 09738193  
Title of Invention: System, Method and Apparatus  
for Constructing a  
Semiconductor Wafer-Interposer  
Using B-Stage Laminates  
First Named Inventor: John Pierce  
Domestic/Foreign Application: Domestic Application  
Filing Date: 2003-07-14  
Effective Receipt Date: 2003-07-14  
Submission Type: Information Disclosure  
Statement  
Filing Type:  
Confirmation number: 1129  
Attorney Docket Number: 1384-1023  
Total Fees Authorized: 180.0  
Payment Category: Credit Card  
Credit Card Number: \*\*\*\*\*2005  
Expiration Date: 09302005  
Card Holder Name: Lawrence R. Youst  
Postal Code: 75230  
RAM Payment Status: RAM success  
RAM User ID: EFSPROD  
RAM Accounting Date: 2003-07-14  
RAM Sequence Number: 734858



Digital Certificate Holder: cn=Scott Taylor Griggs,ou=Registered Attorneys,ou=Patent and  
Trademark Office,ou=Department of Commerce,o=U.S. Government,c=US  
Certificate Message Digest: be8da08ef5bbca1ab0816e337c7df74694120e94

07/15/2003 EFSPROD 00000032 09738193

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